



2 G / 5 G WLAN diplexer

Datasheet - production data

Features

- Low insertion loss in pass band
- High attenuation levels
- High rejection of out-of-band frequencies
- Small footprint: <1.4 mm²

Benefits

- Very low profile (<600 µm after reflow)
- High Q, low loss
- High RF performance
- Tight tolerance
- Bill of materials and area reduction

Applications

- WLAN
- Bluetooth
- Mobile phone application
- Wireless networking

Description

This diplexer targets the use of dual band 2.4 GHz and 5 GHz. The DIP2450-01D3 is a diplexer dedicated to the WLAN/BT application.

It is designed using STMicroelectronics IPD (integrated passive device) technology on non conductive glass substrate to optimize RF performance.

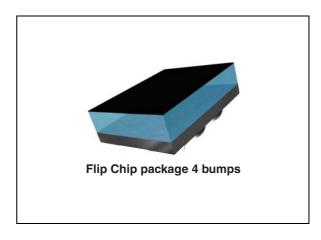
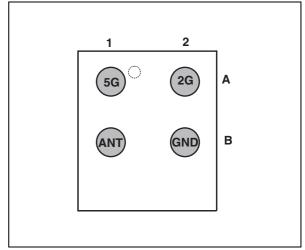


Figure 1. Pin configuration (bump view)



Characteristics DIP2450-01D3

1 Characteristics

Table 1. Absolute rating (limiting values)

Symbol	Parameter	Value			Unit
		Min.	Тур.	Max.	Oilit
P_{AV}	Average power			27	dBm
V _{ESD} antenna and 2G ports	ESD ratings: MIL STD883C (HBM:C = 100 pF, R = 1.5 k Ω , air discharge) Charged device model (CDM) Machine model (MM: C = 200 pF, R = 25 Ω , L = 500 nH)	400 500 100			٧
T _{OP}	Operating temperature range			+85	ºC

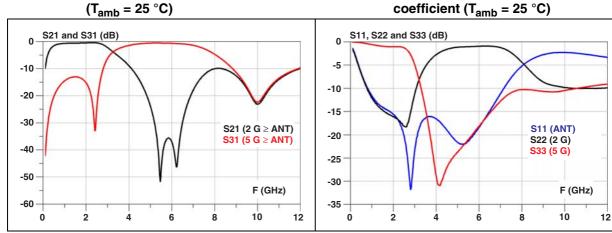
Table 2. Electrical characteristics and RF performance ($T_{amb} = 25$ °C)

Symbol	Parameter	Test condition					
			Min.	Тур.	Max.	Unit	
		Pass band					
f	2 G band pass		2400		2483.5	MHz	
	5 G band pass	4900		5850	MHz		
Z	Nominal impedance		50		Ω		
Return loss		All ports			-17	dB	
S21	2 G to antenna insertion loss	2400 to 2483.5 MHz		0.6	0.7	dB	
S31	5 G to antenna insertion loss	4900 to 5850 MHz		0.6	0.7	dB	
		Attenuation		•		•	
S21	2 G to antenna attenuation	4900 to 5850 MHz	20			dB	
S31	5 G to antenna attenuation	2400 to 2483.5 MHz	18			dB	
	0	ut of band attenuation	•		•	•	
		5850 to 7000 MHz	15				
S21	2 G to antenna attenuation	7000 to 9500 MHz	9			dB	
		9800 to 10500 MHz	16				
S31	5 G to antenna attenuation	9800 to 11650 MHz	11			dB	

DIP2450-01D3 **Characteristics**

Measured performance 1.1

Figure 2. 2 G and 5 G forward transmission Figure 3. 2 G, 5 G and antenna reflection $(T_{amb} = 25 °C)$



2 G insertion loss (T_{amb} = 25 °C) Figure 4.

Figure 5. 2 G attenuation in 5 G band $(T_{amb} = 25 \, ^{\circ}C)$

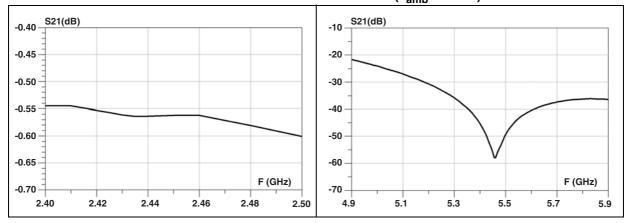
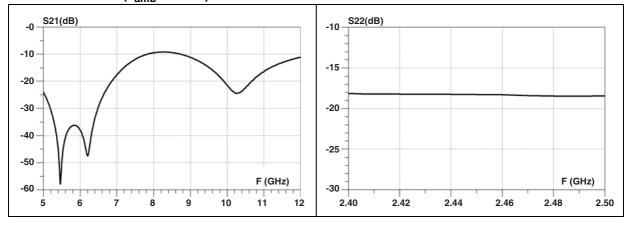


Figure 6. 2 G attenuation in high frequency band ($T_{amb} = 25 \, ^{\circ}C$)

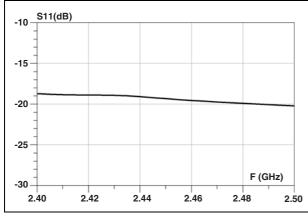
2 G return loss (T_{amb} = 25 °C) Figure 7.



Characteristics DIP2450-01D3

Figure 8. Antenna return loss in 2 G band $(T_{amb} = 25 \, ^{\circ}C)$

Figure 9. Antenna return loss in 5 G band $(T_{amb} = 25 \, ^{\circ}C)$



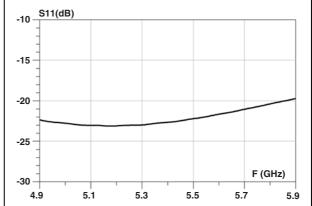


Figure 10. 5 G insertion loss (T_{amb} = 25 °C)

Figure 11. 5 G attenuation in 2 G band (T_{amb} = 25 °C)

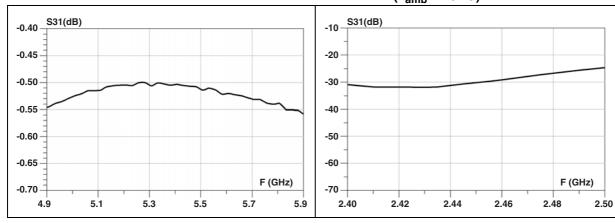
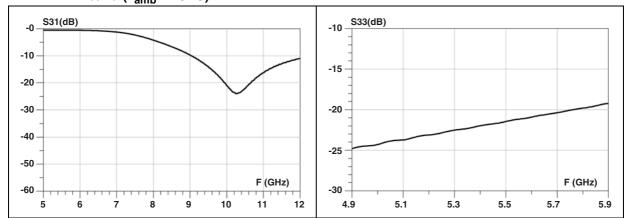


Figure 12. 5 G attenuation in high frequency band $(T_{amb} = 25 \, ^{\circ}C)$

Figure 13. 5 G return loss ($T_{amb} = 25 \,^{\circ}C$)



DIP2450-01D3 Characteristics

Figure 14. 2 G to 5 G isolation (T_{amb} = 25 °C) Figure 15. 2 G to 5 G isolation in 2 G band (T_{amb} = 25 °C)

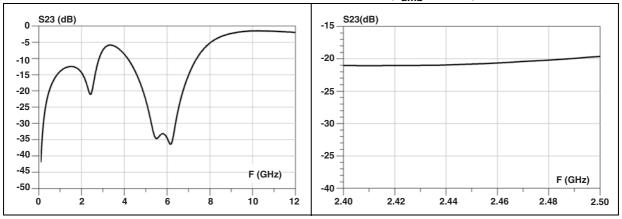
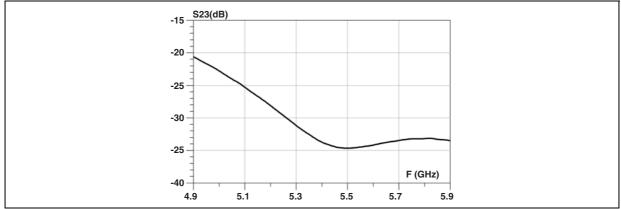


Figure 16. 2 G to 5 G isolation in 5 G band ($T_{amb} = 25$ °C)



2 Application information

Figure 17. Application schematic

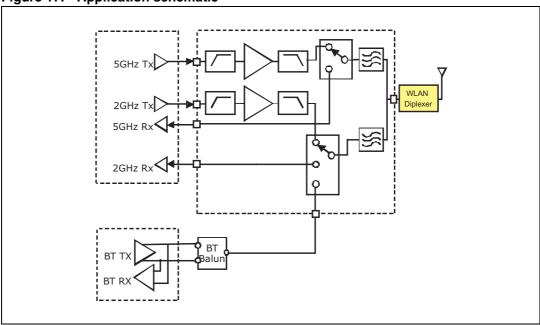
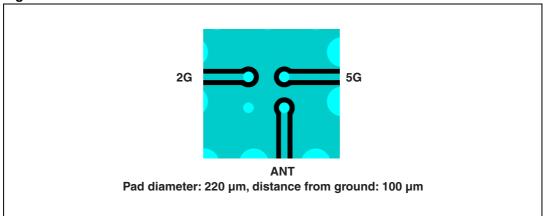


Figure 18. PCB recommendation



DIP2450-01D3 Package information

3 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.

Figure 19. Package dimensions

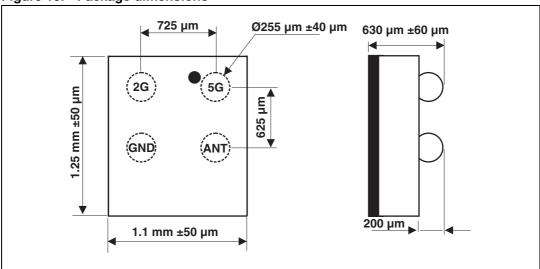
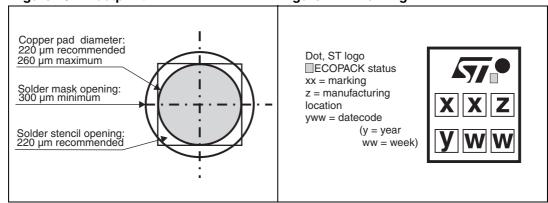


Figure 20. Footprint

Figure 21. Marking



Package information DIP2450-01D3

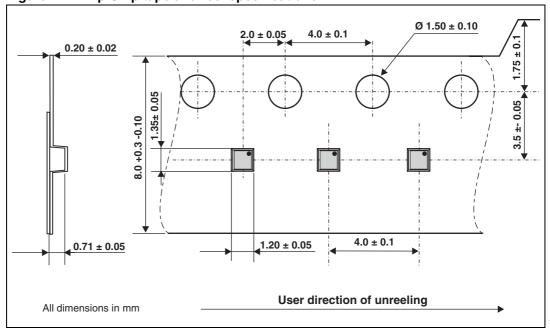


Figure 22. Flip Chip tape and reel specifications

4 Ordering information

Table 3. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
DIP2450-01D3	SA	Flip Chip	1.88 mg	5000	Tape and reel (7")

5 Revision history

Table 4. Document revision history

Date	Revision	Changes
27-June-2012	1	Initial release

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